



ARTEMIS TECHNOLOGY CONFERENCE EMC² Workshop

Madrid, October 6th 2016

WP4 Multi-core Hardware Architectures and Concepts

Rainer Buchty Rolf Meyer, TU Braunschweig e-mail: <u>meyer@c3e.cs.tu-bs.de</u>

WP Lead:

Alexander Lipautz , Infineon AT e-mail: <u>Alexander.Lipautz@infineon.com</u> Mladen Berekovic, TU Braunschweig e-mail: <u>berekovic@c3e.cs.tu-bs.de</u> Haris Isakovic, TU Wien e-mail: <u>haris@vmars.tuwien.ac.at</u>



EMC² WP4 Architectures and Concepts Agenda



- Technical Overview
- > Objectives
- Highlights



MC² Technical Overview 5 Technology Lanes







EMC² Technical Overview Spread over System Segments









- Hardware platforms and tools applied to internal use-cases
- Ongoing evaluation and knowledge transfer of the proposed technologies and tools with other WPs and Living Labs
- Development of Hardware Technologies and Demonstrators following requirements and along Technology Lanes
- Evaluate interfaces to run-time (WP3) and Application Models/Tools (WP2)
- Evaluate Dissemination to LLs (WP12)



Technology Transfer



				VP7					84W		6dM				WP10				WP11				WP12						
			UC_ADAS and C2X	UC_Highly automated driving	UC_Design and validation of next generation hybrid powertrain / E-Drive	or fu	UC_Infotainment and eCall Application Multi- Critical Application	UC_Next Generation Electronic Architecture for Commercial Vehicles	UC_Multi Domain Avionic Architecture	UC_Hybrid Avionics Integrated Architecture	UC_MPSoC Hardware for Space	UC_MPSoC Software and Tools for Space	UC_Optical Payload Applications	UC_Platform Applications	UC_Radar Payload Application	UC_Drives and electric motors in industrial applications	UC_Identification and authentication	UC_Tracking	UC_Manufacturing quality control by 3D inspection	UC_Multimedia communication WEBRTC	UC_Open deterministic networks	UC_Autonomic home networking	UC_Ultralowpower high datarate communi- cation	UC_Synchronized low-latency deterministic networks	UC_Seismic surveying by ship	UC_Video surveillance for critical infra- structure	UC_Medical imaging	UC_Control applications for critical infra- structure	UC_Railway applications
	No.	Technology title	T7.1	T7.2	T7.3	T7.4	T7.5	T7.6	Т8.1	T8.2	Т9.1	T9.2	T9.3	Т9.4	T9.5	T10.1	T10.2	T10.3	T10.4	Т11.1	Т11.2	T11.3	T11.4	T11.5	T12.1	T12.2	T12.3	T12.4	T12.5
WP4	4.1	Heterogenous Multiprocessor SoC architectures (T4.1)	2					2			2		1				4												
		Dynamic reconfiguration on HW accelerators and reconfigurable logic (T4.2)			1						1			1															
	4.3	Networking (T4.3)	2		1												4					3	3			2			
	4.4	Verification and Validation Techniques (T4.4)			1						3						4												

Technology transfer phases							
Definition							
Evaluation							
Development							
In Transfer							
Transfer complete							

Scope 1: Complete implementation into use cases in the project

Scope 2: Partial implementation into use case

Scope 3: Will be transferred to LL (WP7-12) but not implemented into use case

Scope 4: Topic for future applications; technology transfer subsequent to EMC2



EMC2HighlightsProgress & Results



WP4 Achievements per technology



USPs/Highlights of WP4



- Architecture and Hardware support for mixed-criticality applications on multi-core platform along the 5 technology lanes
 - EMC2-DP platform *Reconfiguration (T4.4)*
 - Software Defined Asymmetric Multiprocessing on EMC2-DP ZYNQ platform – Architecture(T4.2)
 - Heterogeneous TTNoC many-core architecture Networking (T4.3)
 - High-Accurate Distributed Control Systems Networking (T4.3)
 - Analog-Mixed-Signal Power System for MC Multi-Core - Architecture
- System optimisation for MCMC applications
 - Time-of-Flight 3D Imaging Application & Demonstration (T4.6)
 - Application-specific Exploration and Optimization MCMC Hardware with Virtual Hardware platform – Virtualization







EMC2-DP, Zynq Base board: HDMI in and out, Ethernet, PCIexpress, SATA







Software Defined Asymmetric Multiprocessing on EMC2-DP ZYNQ platform

- EMC2-DP is Sundance HW platform enabling to use System on Module Component with ZYNQ.
- EMC2-DP is compatible with the Xilinx Software Defined System on Chip (SDSoC 2015.4) flow. UTIA & Sundance designed support for SDSoC.
- EMC2-DP parameters: MicroBlaze and UTIA EdkDSP floating point accelerator deliver:
 - Adaptive LMS filter: 776 MFLOP/s
- This is 2.3x faster than 666 MHz ARM A9 CPU optimized SW with NEON vector proc. unit.
- EMC2-DP HW image processing accelerators are generated by the SDSoC from C. See figure: Edge detection on Full HD Video:
 - EMC2-DP ARM + SDSoC HW: 60.0 Frames/s
 - EMC2-DP ARM + platform SW: 5.3 Frames/s







Demonstration





Object detection by HLS on EMC2-DP ZYNQ platform

> Objectives:

- WP12.2 (LL6) is using the EMC2-DP is used for one solution to their object detection problem.
- The idea is to use the FPGA for a object detection, but generate the FPGA code via highlevel synthesis.

One solution of multiple prototypes





Heterogeneous TTNoC many-core architecture (TU Wien)

- Objective: Building a deterministic heterogeneous architecture on Altera Arria V SoC
- > Key achievements:
 - Integration of TTNoC on the Arria V SoC platform.
 - The architecture combines 4 Nios 2 components and an ARM Cortex A9 component.
 - Full time and space isolation of individual components, designed for mixed-criticality applications.



Block diagram of the architecture



Highlights: T4.3/T4.6

High-Accurate Distributed Control Systems (SevenS)

- Development of new White Rabbit nodes for the project to improve scalability and stability of the distributed frequency:
 - White Rabbit ZEN
 - White Rabbit LEN
- In terms of time in distributed networks considered as critical data, we have adapted White-Rabbit (able to provide time with <1ns accuracy) and also using our own devices, two distribute time over 14 hops maintaining synchronization capabilities with a jitter in 1-PPS signal under 250ps
- A new clock distribution mechanism (Peer-to-Peer and PeerDelay) to provide White-Rabbit with the possibility of being adapted to industrial Ethernet networks, which opens doors to the development of redundancy protocols such as High-availability Seamless Redundancy (HSR).















High-Accurate Distributed Control Systems (SevenS)

> Objectives:

- Improvement of the synchronization performance in terms of jitter and skew of the distributed signal and the scalability of the timing network (WP4)
- Implementation of redundant protocols (WP1) using new mechanisms to distribute time which includes the development of transparent clocks (WP4) (better synchronization, more scalable)
- Two Prototypes



Prototype A: <1ns accuracy deterministic time distribution system



Main features:

- WR-ZEN board as main time provider (better oscillator)
- WR-LEN, a double-port WR node
- Accuracy <1ns synchronization
- Pulse per Second and 10MHz outputs
- Daisy-chain configurations with less than 250ps of jitter
- Scalable up to 12 nodes in cascade
- Time distribution using WR-PTP and IRIG-B.
- Remote Time Units (RTU) connected to WR devices using IRIG-B



Prototype A

Setup to demonstrate the scalability of the timing solution and also the utilization of different timing protocols in the same network.





Prototype B: Single point of failure avoidance using Transparent Clocks (Redundancy Protocols)



Main features:

- > <1ns synchronization</pre>
- I Pulse per Second (1-PPS) and 10MHz outputs
- Redundancy Capabilities (HSR implementation for timing)
- Able to recover from a link failure in ~zero-time.
- 1-PPS skew improvement in terms of ~50ps



Prototype B

- Implementation of the HSR redundancy protocol using Transparent Clocks to recover from a system failure in ~zero-time.
- Demo will consist in how two devices connected to a HSR ring are able to remain 1-ns synchronized even after the main time reference is lost (link down).







Analog-Mixed-Signal Power System (Infineon)

- First full functional safety compliant Analog-Mixed-Signal Power System for multi core and mixed critical systems including standby controller, robust concept implementation, out of operating range functionality is now fully available for next generation of products.
- It introduce highest flexibility and have very efficient regulators with SMPS power optimization features, revers back biasing and dynamic voltage scaling.



Block diagram of the concept



Highlights: T4.6

Time-of-Flight 3D Imaging (Infineon)

- Objective: Exploration of novel Time-of-Flight 3D imaging concepts targeting multi-cores and mixed-criticality
- Key achievements
 - ToF / RGB sensor fusion
 - First time high-performance sensor fusion solution for mobile devices achieved
 - Upscaled resolution, increased sharpness, less noise, less motion artifacts, high FPS
 - HW-accel. ToF processing
 - Novel Zynq-based system solution for mixed-critical app.



ToF 3D camera



Low-res. ToF image



High-res. RGB image



ToF/RGB fused 3D image







Time-of-Flight 3D Imaging (Infineon)

- Objective: Exploration of novel Time-of-Flight 3D imaging concepts targeting multi-cores and mixedcriticality
- Setup
 - ToF / RGB sensor
 - Zynq platform
 - Aurix
 - PC



Hardware Setup



Example



All models available in loosely timed (LT), and approximately timed (AT) flavor of TLM2.0.

Implemented models





Fault tolerant Heterogeneous Multi Processor Quadcopter Simulation WP2/WP4

> Objectives:

- Provide an open mixed critical use application.
- Simulate a fault tolerant motor control
 - 3 subsystems with different architectures
 - executing 3 different algorithms
 - One hardware voter
- Work In Progress
- The design is build to be used with the EMC2-DP







